NOTES:
1. SOLDERING TO BE IN PER NASA SPECIFICATION 14800.4(A)-1.
2. TOLERANCES: ALL PLATES TO BE IN POS-0Z. SPOT-CONAD WITH F/N 17.
3. VACUUM BAKE P1 (F/N 3) AT 90°C FOR 72 HOURS.
4. TOLERANCE: ALL PLATES TO BE IN POS-0Z. SPOT-CONAD WITH F/N 17.
5. ASSEMBLY: AS 6800132/22 ALUMINUM POWER.
6. PLACE “CHECKSUM” LABEL ON CPG PLATE IN LOCATION WHERE IT WAS INSTALLED.
7. SPOT-CONAD CORNERS OF U1 AND CEN.11,14-17,20,22,35,35,66,77 USING F/N 16.
8. PARTS TO BE CLEANED VISUALLY INSPECTED PRIOR TO INSTALLATION.
9. EPOXY ALL MOUNTED G0 AND G1-1 TO THE BOARD USING F/N 15.
10. EPOXY LENS TO BE AS TIGHT AS POSSIBLE.
11. EPOXY F/N 4, 5, AND 20 TO F/N 1 USING F/N 13.
12. MOUNTING AND OPERATION SPECIFIED STARTING LOCATION FOR EPOXYING END PORTION OF MIDGET UNIT.
13. MEASURE UNMOUNTED CAPACITORS PRIOR TO INSTALLATION; NOTE POLARITY OF THE METER.
14. WASH FOR CONFORMAL COAT AS NEEDED.
15. COMBINATION COAT AS NEEDED.
16. TOLERANCE: ALL PLATES TO BE IN POS-0Z.
17. MOUNTING AND ASSEMBLY: ASSEMBLY TO VACUUM BAKE P1 (F/N 3) AT 90°C FOR 72 HOURS.
18. EPOXY LENS TO BE AS TIGHT AS POSSIBLE.
19. DO NOT INSTALL TEST HEADERS.